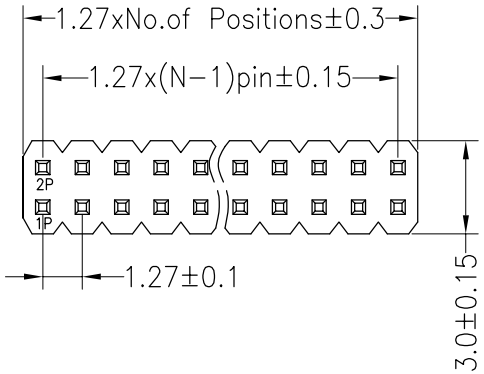
HSF RoHS

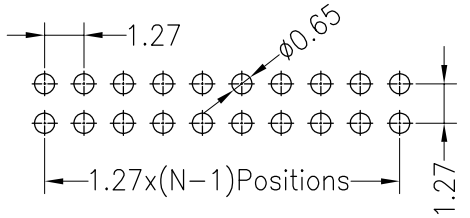
FILE NO :E362810

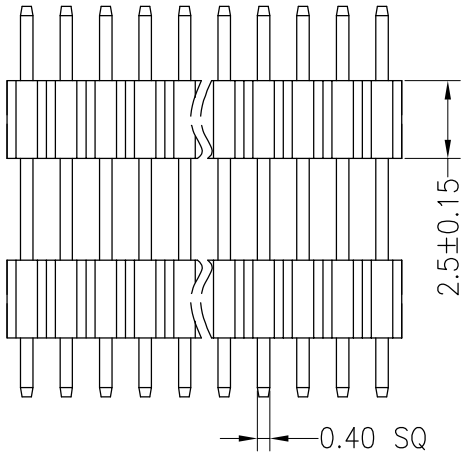
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°C to +105°C

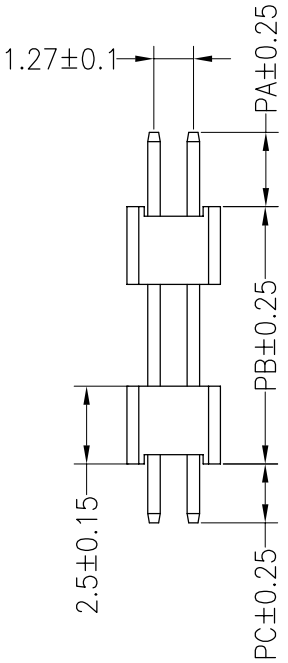
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1425 22 XX X N XX S XXX X 0X

- No.of Pins: 2*1~2*50
- Insulator Material Option:
  - A=BK−PBT
  - B=BK−PA66
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- Contact Plating:
  - G0:Gold Flash
  - G1:3U" Gold
  - G2:5U" Gold
  - G3:10U" Gold
  - G4:15U" Gold
  - G5:30U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- Pin Length
- Packing:
  - 0=PE Bag
  - A=Tray
  - T=Tube

Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	4.00	5.00	2.00	11.00
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.05.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.05.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	142522XXXNXXSXXXX0X
TITLE:	1.27PH H2.5+H2.5mm 2xNpin DIP